

2841

TRANSMITTAL LETTER
(General - Patent Pending)

Docket No.
113197-009

In Re Application Of:

Tanabe, N., et al.

Serial No.
09/844,097

Filing Date
April 27, 2001

Examiner
Tuan T. Dinh

Group Art Unit
2841

Title: **FLEXIBLE PRINTED CIRCUIT BOARD**

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Response To Office Action (7 pgs.); Substitute Specification (11 pgs.); Substitute Specification With Markings To Show Changes Made (11 pgs.); Revised Drawing (1 sheet); return receipt postcard.

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in the above identified application.

- ☒ No additional fee is required.
- ☐ A check in the amount of _____ is attached.
- ☒ The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. **02-1818** as described below. A duplicate copy of this sheet is enclosed.
- ☐ Charge the amount of _____
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- ☒ Charge any additional fee required.


Signature

Dated: **March 19, 2002**

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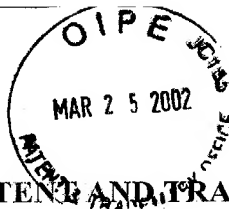
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Robert J. Buccieri

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Tanabe, N., et al.
Appl. No.: 09/844,097
Filed: April 27, 2001
Title: FLEXIBLE PRINTED CIRCUIT BOARD
Art Unit: 2841
Examiner: Tuan T. Dinh
Docket No.: 113197-009

Commissioner for Patents
Washington, DC 20231

RESPONSE TO OFFICE ACTION

Sir:

This Response is submitted in response to the Office Action dated December 28, 2001.
Please amend the above-identified patent application as follows.

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In the Specification:

Please substitute the enclosed revised Substitute Specification for the Specification submitted with the filing of the Application.

In the Abstract:

Please substitute the enclosed revised Abstract attached to the Substitute Specification for the Abstract submitted with the filing of the Application.

In the Drawings:

Please amend Fig. 1 of the drawings per the enclosed copy of Fig. 1 marked in red ink.

In the Claims:

Please amend claims 1, 5, and 6 to read as follows.

1. (Amended) A flexible printed circuit board comprising a base film; a base film side adhesive layer provided on the base film; a metal foil layer on which pattern circuit is

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